

RJP65T43DPM

650V - 20A - IGBT High Speed Switching R07DS1201EJ0200 Rev.2.00 Dec.01.2020

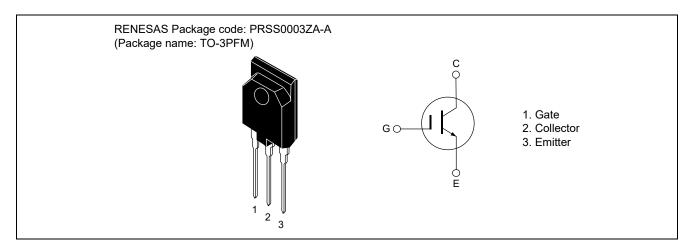
Features

- Trench gate and thin wafer technology (G7H series)
- · Isolated package
- Low collector to emitter saturation voltage $V_{CE(sat)} = 1.8 \text{ V typ.}$ (at $I_C = 20 \text{ A}$, $V_{GE} = 15 \text{ V}$, $Ta = 25 \, ^{\circ}\text{C}$)
- High speed switching t_f = 28 ns typ. (at V_{CC} = 400 V, V_{GE} = 15 V, I_C = 20 A, R_g = 10 Ω , Ta = 25 °C)
- Operation frequency (20 kHz \leq f \leq 100kHz)
- Not guarantee short circuit withstand time
- Applications: PFC
- Quality grade: Standard

Key Performance

Туре	Vces	lc	V _{CE(sat)} , T _C =25°C	Tj
RJP65T43DPM	650 V	20 A	1.8 V	175 °C

Outline



Absolute Maximum Ratings

(Tc = 25 °C)

Item		Symbol	Ratings	Unit	
Collector to emitter ve	oltage	Vces	650	V	
Gate to emitter voltage	је	V _{GES}	±30	V	
Collector current	Tc = 25 °C	Ic Notes1	40	Α	
	Tc = 100 °C	Ic Notes1	20	Α	
Collector peak currer	nt	ic(peak) Notes1	150	Α	
Collector dissipation		Pc	68.8	W	
Junction temperature	;	Tj Notes2	175	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note: Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for Handling and Usage of Semiconductor Devices) and individual reliability data.

Notes: 1. Pulse width limited by safe operating area.

2. Please use this device in the thermal conditions which the junction temperature does not exceed 175 °C. Renesas IGBT Application Note is disclosed about reliability test and application condition up to 175 °C.

Thermal Resistance Characteristics

(Tc = 25 °C)

Item	Symbol	Max. Value Notes3	Unit
Junction to case thermal resistance	R _{th(j-c)}	2.18	°C/W

Notes: 3. Designed target value on Renesas measurement condition. (Not tested)

Electrical Characteristics

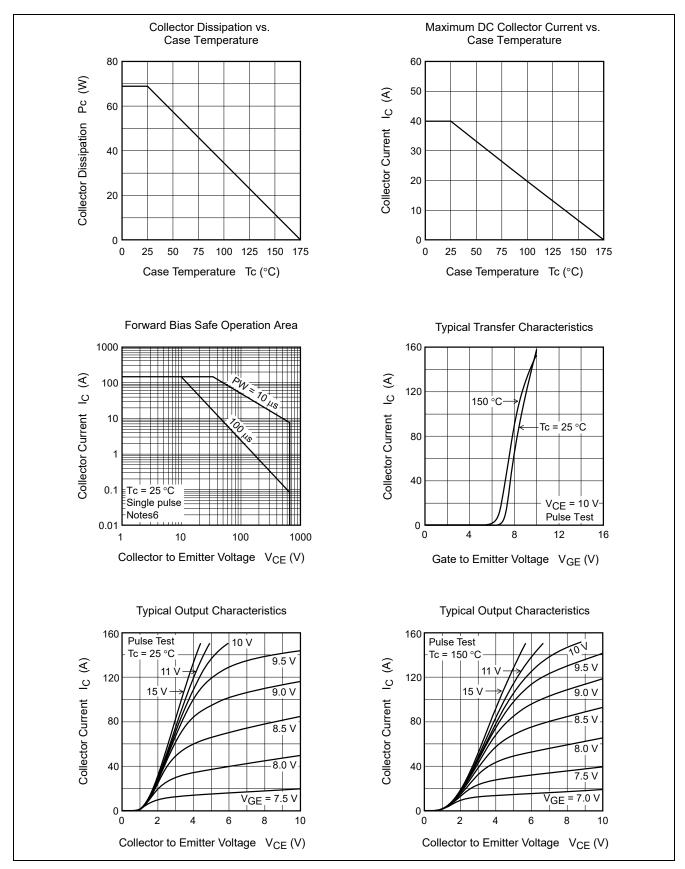
(Tc = 25 °C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector to emitter leakage current	Ices	_	_	1	μА	V _{CE} = 650 V, V _{GE} = 0 V
Gate to emitter leakage current	I _{GES}	_	_	±1	μА	V _{GE} = ±30 V, V _{CE} = 0 V
Gate to emitter threshold voltage	$V_{GE(th)}$	4.0	_	7.0	V	V _{CE} = 10V, I _C = 0.67 mA
Collector to emitter saturation voltage	V _{CE(sat)}	_	1.8	2.4	V	I _C = 20 A, V _{GE} = 15V Notes4
Input capacitance	Cies	_	1320	_	pF	V _{CE} = 25 V
Output capacitance	Coes	_	37	_	pF	V _{GE} = 0 V
Reveres transfer capacitance	Cres	_	26	_	pF	f = 1 MHz
Total gate charge	Qg	_	70	_	nC	V _{GE} = 15 V
Gate to emitter charge	Qge	_	8	_	nC	V _{CE} = 400 V
Gate to collector charge	Qgc	_	31	_	nC	Ic = 20 A
Turn-on delay time	t _{d(on)}	_	30	_	Ns	V _{CC} = 400 V
Rise time	tr	_	20	_	ns	V _{GE} = 15 V
Turn-off delay time	t _{d(off)}	_	107	_	ns	Ic = 20 A
Fall time	t _f	_	28	_	ns	Rg = 10Ω
Turn-on loss energy	Eon	_	0.17	_	mJ	T _C = 25 °C Inductive load Notes5
Turn-off loss energy	E _{off}	_	0.11	_	mJ	mudelive load
Total switching energy	E _{total}	_	0.28	_	mJ	
Turn-on delay time	t _{d(on)}	_	31	_	Ns	V _{CC} = 400 V
Rise time	tr	_	20	_	ns	V _{GE} = 15 V
Turn-off delay time	t _{d(off)}	_	114	_	ns	I _C = 20 A
Fall time	t _f	_	51	_	ns	$Rg = 10 \Omega$
Turn-on loss energy	Eon	_	0.25	_	mJ	T _C = 150 °C Inductive load Notes5
Turn-off loss energy	E _{off}	_	0.24	_	mJ	
Total switching energy	E _{total}	_	0.49	_	mJ	

Notes: 4. Pulse test

5. Switching time test circuit and waveform are shown below.

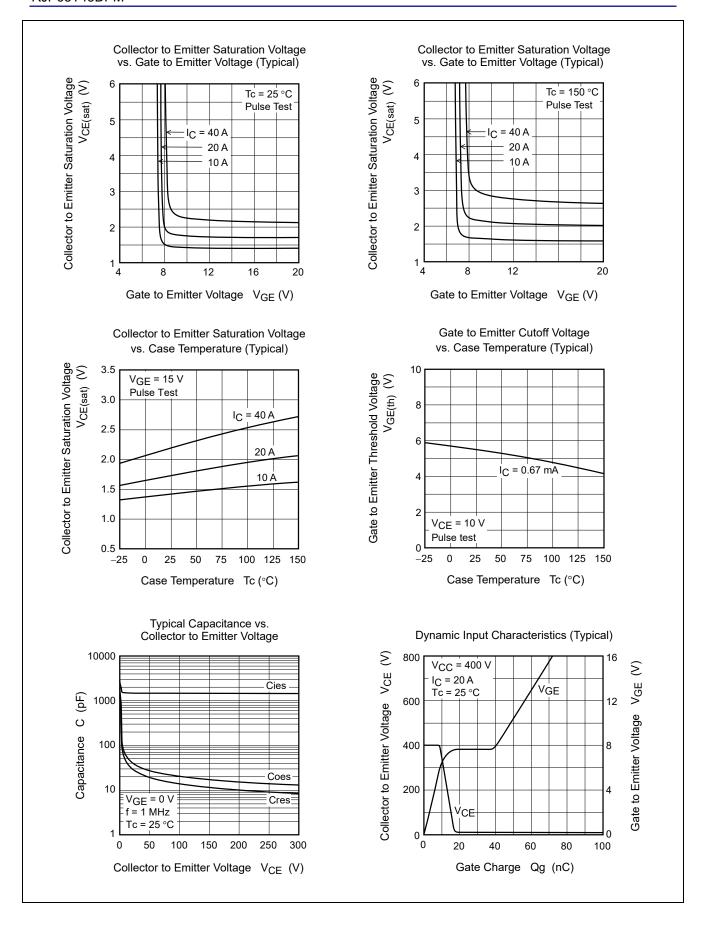
Main Characteristics

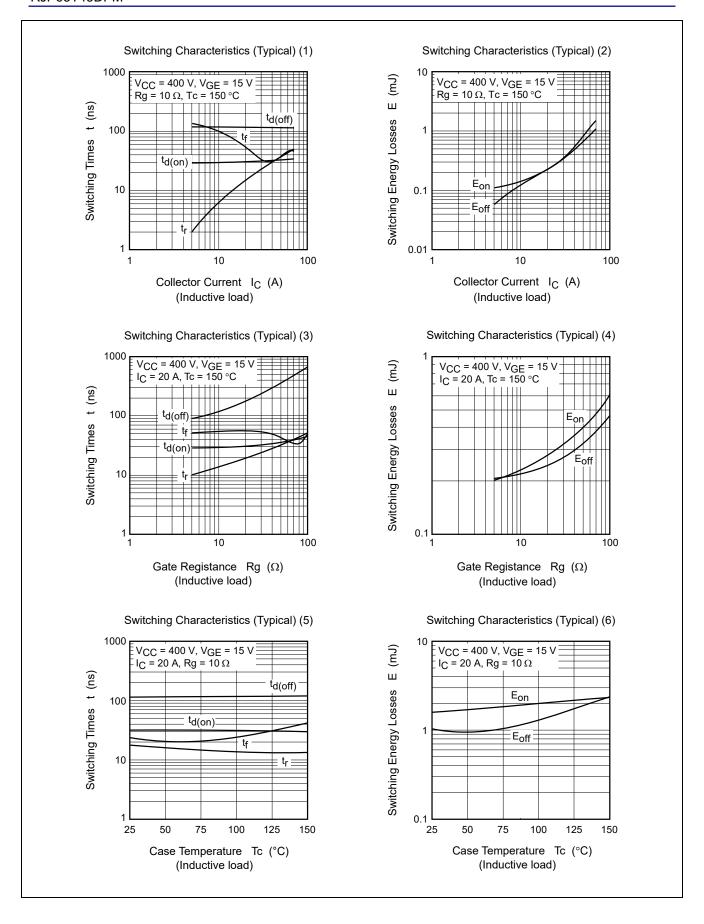


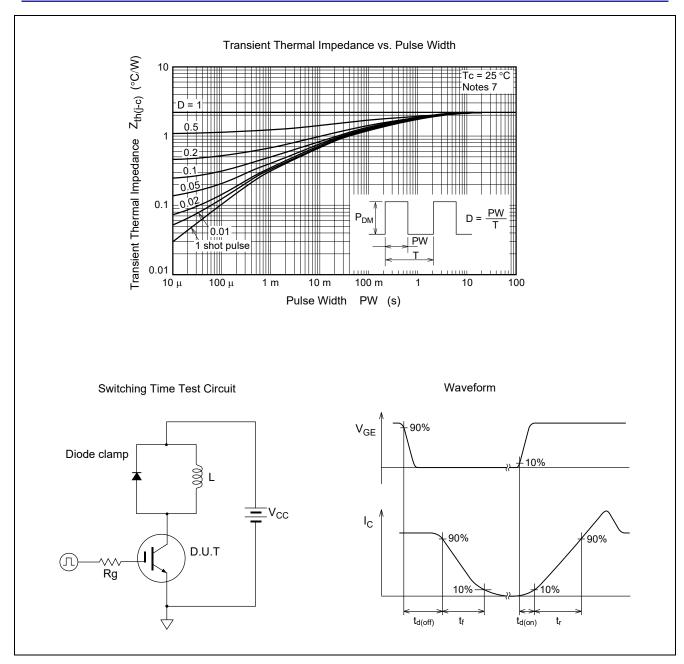
Notes: 6. Designed target value on Renesas measurement condition. (Not tested)

Renesas recommends that operating conditions are designed according to a document "Power MOS FET •

IGBT Attention of Handling Semiconductor Devices".

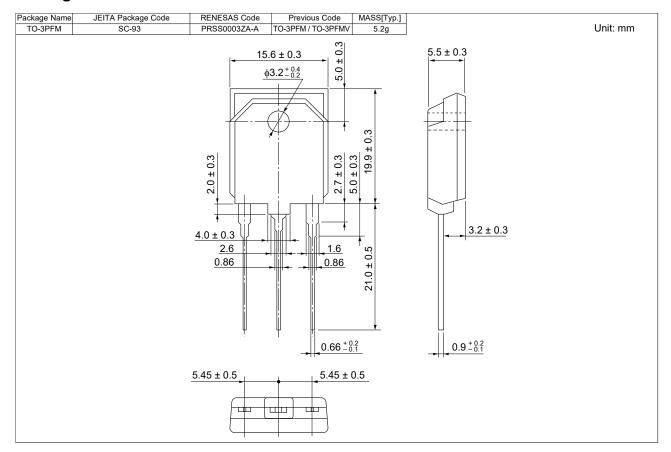






Notes: 7. Designed target value on Renesas measurement condition. (Not tested)

Package Dimensions



Ordering Information

Orderable Part No.	Quantity	Shipping Container		
RJP65T43DPM-00#T1	360 pcs	Box (Tube)		

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